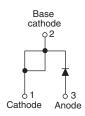


# Hyperfast Rectifier, 8 A FRED Pt®





PRODUCT SUMMARY					
Package	TO-220AC				
I <sub>F(AV)</sub>	8 A				
V <sub>R</sub>	600 V				
V <sub>F</sub> at I <sub>F</sub>	1.3 V				
t <sub>rr</sub> typ.	18 ns				
T <sub>J</sub> max.	175 °C				
Diode variation	Single die				

#### **FEATURES**

- Hyperfast recovery time
- Low forward voltage drop
- 175 °C operating junction temperature
- · Low leakage current
- AEC-Q101 qualified, meets JESD 201 class 2 whisker test







ROHS COMPLIANT HALOGEN FREE

#### **DESCRIPTION / APPLICATIONS**

State of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS, inverters or as freewheeling diodes.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Repetitive peak reverse voltage	$V_{RRM}$		600	V				
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 144 °C	8	Α				
Non-repetitive peak surge current	I <sub>FSM</sub>	T <sub>J</sub> = 25 °C	90					
Repetitive peak forward current	I <sub>FM</sub>		16					
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-65 to +175	°C				

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	Ι <sub>R</sub> = 100 μΑ	600	-	-			
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 8 A	-	2.0	2.4	V		
		I <sub>F</sub> = 8 A, T <sub>J</sub> = 150 °C	-	1.3	1.8			
Reverse leakage current		V <sub>R</sub> = V <sub>R</sub> rated	-	0.3	50			
neverse leakage current	I <sub>R</sub>	T <sub>J</sub> = 150 °C, V <sub>R</sub> = V <sub>R</sub> rated	-	55	500	μA		
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 600 V	-	17	-	pF		
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body	-	8.0	-	nH		



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>C</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS		
		$I_F = 1 A, dI_F/dt = 100$	$I_F = 1 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$		18	-		
Reverse recovery time		$I_F = 8 \text{ A}, dI_F/dt = 100$	V = 30 V	-	20	-	no	
heverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	25	-	ns	
		T <sub>J</sub> = 125 °C	$I_F = 8 \text{ A}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$ $V_B = 390 \text{ V}$	-	40	-		
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	2.4	-	А	
		T <sub>J</sub> = 125 °C		-	4.8	-		
Davage gasayan ahara	0	T <sub>J</sub> = 25 °C		-	25	-	nC	
Reverse recovery charge	$Q_{rr}$	T <sub>J</sub> = 125 °C		-	120	-	nc nc	
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 125 °C		I <sub>F</sub> = 8 A	-	33	-	ns
Peak recovery current	I <sub>RRM</sub>		$dI_F/dt = 600 \text{ A/}\mu\text{s}$ $V_R = 390 \text{ V}$	-	12	-	А	
Reverse recovery charge	Q <sub>rr</sub>			-	220	-	nC	

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-65	-	175	°C	
Thermal resistance, junction to case	R <sub>thJC</sub>		-	1.4	2		
Thermal resistance, junction to ambient per leg	R <sub>thJA</sub>	Typical socket mount	-	-	70	°C/W	
Thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	-	0.5	-		
Maiabt			-	2.0	-	g	
Weight			-	0.07	-	oz.	
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)	
Marking device		Case style TO-220AC	8ETH06H				

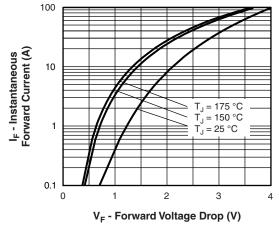


Fig. 1 - Typical Forward Voltage Drop Characteristics

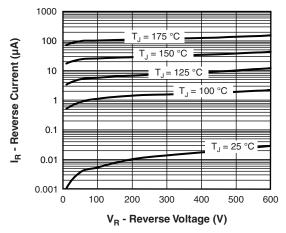


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

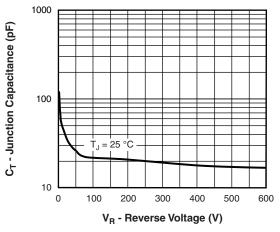


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

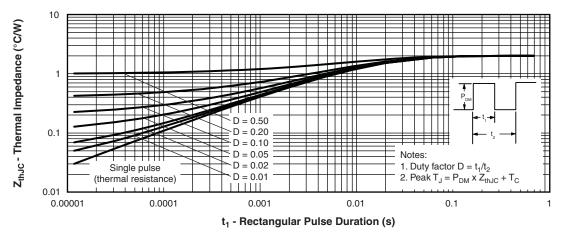


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

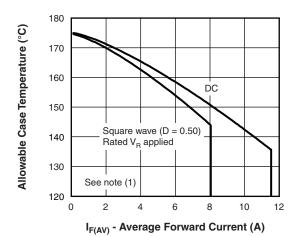


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

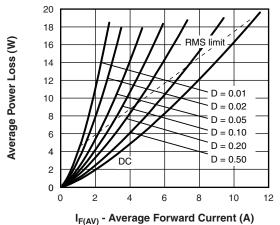


Fig. 6 - Forward Power Loss Characteristics

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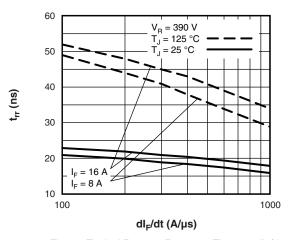


Fig. 7 - Typical Reverse Recovery Time vs.  $dI_{\text{F}}/dt$ 

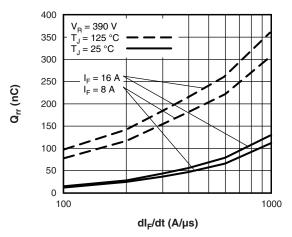
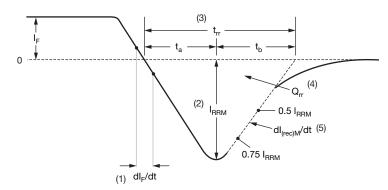


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

#### Note

 $\begin{array}{ll} \text{(1)} \ \ \text{Formula used:} \ T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \text{Forward power loss} = I_{F(AV)} \times V_{FM} \ \text{at } (I_{F(AV)}/D) \ \text{(see fig. 8)}; \\ Pd_{REV} = \text{Inverse power loss} = V_{R1} \times I_R \ \text{(1 - D);} \ I_R \ \text{at } V_{R1} = \text{Rated } V_R \\ \end{array}$ 



- (1) dl<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3)  $\rm t_{rr}$  reverse recovery time measured from zero crossing point of negative going  $\rm I_{r}$  to point where a line passing through 0.75  $\rm I_{RRM}$  and 0.50  $\rm I_{RRM}$  extrapolated to zero current.
- (4)  $\mathbf{Q}_{rr}$  area under curve defined by  $\mathbf{t}_{rr}$  and  $\mathbf{I}_{RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

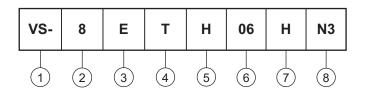
(5) dl<sub>(rec)M</sub>/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>

Fig. 9 - Reverse Recovery Waveform and Definitions



### **ORDERING INFORMATION TABLE**

### Device code



1 - Vishay Semiconductors product

2 - Current rating (8 = 8 A)

3 - E = single diode

4 - T = TO-220, D<sup>2</sup>PAK

5 - H = hyperfast recovery

6 - Voltage rating (06 = 600 V)

7 - H = AEC-Q101 qualified

8 - Environmental digit:

N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

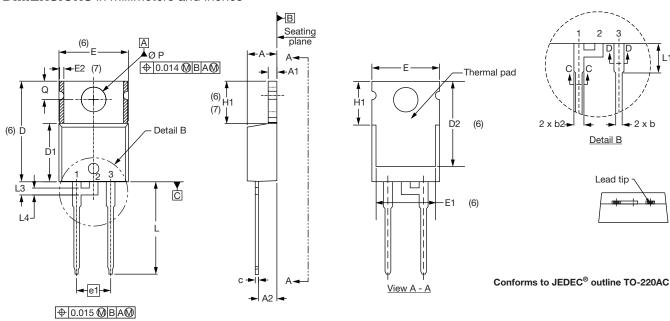
ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-8ETH06HN3	50	1000	Antistatic plastic tube			

LINKS TO RELATED DOCUMENTS					
Dimensions	TO-220AC	www.vishay.com/doc?95221			
Part marking information	TO-220ACHN3	www.vishay.com/doc?95068			



### **TO-220AC**

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIN	IETERS	INCHES		NOTES	
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	4.25	4.65	0.167	0.183		
A1	1.14	1.40	0.045	0.055		
A2	2.56	2.92	0.101	0.115		
b	0.69	1.01	0.027	0.040		
b1	0.38	0.97	0.015	0.038	4	
b2	1.20	1.73	0.047	0.068		
b3	1.14	1.73	0.045	0.068	4	
С	0.36	0.61	0.014	0.024		
c1	0.36	0.56	0.014	0.022	4	
D	14.85	15.25	0.585	0.600	3	
D1	8.38	9.02	0.330	0.355		
D2	11.68	12.88	0.460	0.507	6	
E	10.11	10.51	0.398	0.414	3, 6	

MILLIMETERS		INCHES		NOTES
MIN.	MAX.	MIN.	MAX.	NOTES
6.86	8.89	0.270	0.350	6
-	0.76	-	0.030	7
4.88	5.28	0.192	0.208	
5.84	6.86	0.230	0.270	6, 7
13.52	14.02	0.532	0.552	
3.32	3.82	0.131	0.150	2
1.78	2.13	0.070	0.084	
0.76	1.27	0.030	0.050	2
3.54	3.73	0.139	0.147	
2.60	3.00	0.102	0.118	
	MIN. 6.86 - 4.88 5.84 13.52 3.32 1.78 0.76 3.54	MIN.         MAX.           6.86         8.89           -         0.76           4.88         5.28           5.84         6.86           13.52         14.02           3.32         3.82           1.78         2.13           0.76         1.27           3.54         3.73	MIN.         MAX.         MIN.           6.86         8.89         0.270           -         0.76         -           4.88         5.28         0.192           5.84         6.86         0.230           13.52         14.02         0.532           3.32         3.82         0.131           1.78         2.13         0.070           0.76         1.27         0.030           3.54         3.73         0.139	MIN.         MAX.         MIN.         MAX.           6.86         8.89         0.270         0.350           -         0.76         -         0.030           4.88         5.28         0.192         0.208           5.84         6.86         0.230         0.270           13.52         14.02         0.532         0.552           3.32         3.82         0.131         0.150           1.78         2.13         0.070         0.084           0.76         1.27         0.030         0.050           3.54         3.73         0.139         0.147

### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimension E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, D2 (minimum) where dimensions are derived from the actual package outline



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